**Product data sheet** 

# 1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 3 A
- Reverse voltage: V<sub>R</sub> ≤ 30 V
- · Low forward voltage
- · High power capability due to clip-bond technology
- Small and flat lead SMD plastic package
- · Suitable for both reflow and wave soldering

# 3. Applications

- · Low voltage rectification
- · High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- · Reverse polarity protection
- · Low power consumption applications

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> $\leq$ 140 °C	-	-	3	А
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	-	30	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A; T <sub>j</sub> = 25 °C	-	400	450	mV
I <sub>R</sub>	reverse current	$V_R = 30 \text{ V}; T_j = 25 \text{ °C}$	-	55	150	μΑ

# 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	, , ,	к <del>_[K]</del> -а
2	A	anode	CFP5 (SOD128)	sym001

[1] The marking bar indicates the cathode.



# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package						
	Name	Description	Version				
PMEG3030BEP		plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128				

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG3030BEP	A6

# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	30	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 70 °C	[1]	-	3	А
		$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 140 °C		-	3	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	50	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	625	mW
			[3]	-	1.05	W
			[1]	-	2.1	W
Т <sub>ј</sub>	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

- Device mounted on a ceramic PCB,  $Al_2O_3$ , standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ang a)	thermal resistance from	[1	[1] [2]	-	-	200	K/W
	junction to ambient		[1] [3]	-	-	120	K/W
			[1] [4]	-	-	60	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

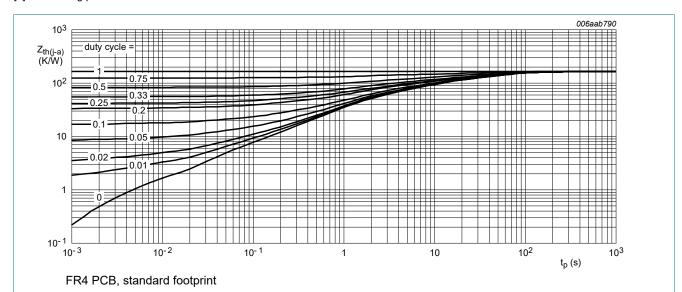


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

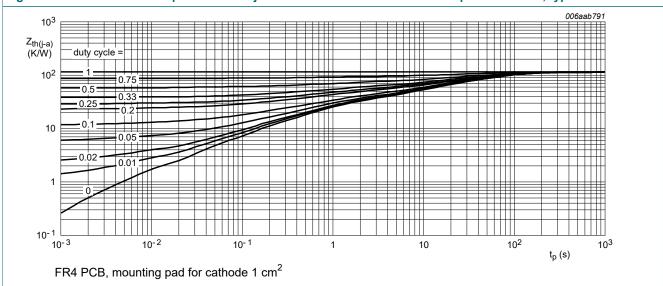
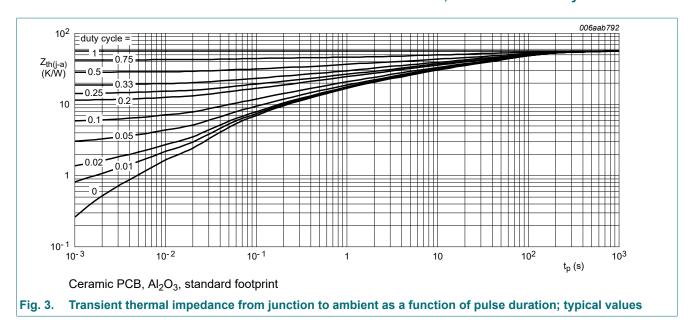


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

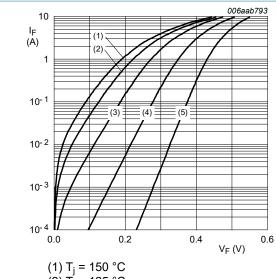
Product data sheet



## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	N	/lin	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 A; T <sub>j</sub> = 25 °C	-		280	320	mV
		I <sub>F</sub> = 0.5 A; T <sub>j</sub> = 25 °C	-		330	380	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-		350	400	mV
		I <sub>F</sub> = 1.5 A; T <sub>j</sub> = 25 °C	-		365	420	mV
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C	-		380	440	mV
		I <sub>F</sub> = 3 A; T <sub>j</sub> = 25 °C	-		400	450	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 5 V; T <sub>j</sub> = 25 °C	-		6	-	μA
		V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-		9	-	mA
		V <sub>R</sub> = 30 V; T <sub>j</sub> = 25 °C	-		55	150	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-		500	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-		170	-	pF



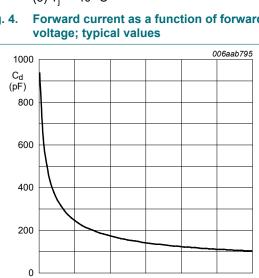
(2)  $T_i = 125 °C$ 

 $(3) T_i = 85 ^{\circ}C$ 

 $(4) T_i = 25 ^{\circ}C$ 

(5)  $T_i = -40 \,^{\circ}$ C

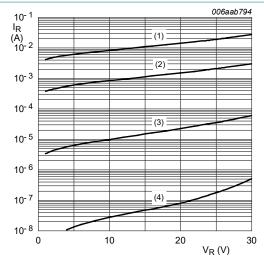
Fig. 4. Forward current as a function of forward voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ °C}$ 

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Fig. 6. Diode capacitance as a function of reverse voltage; typical values



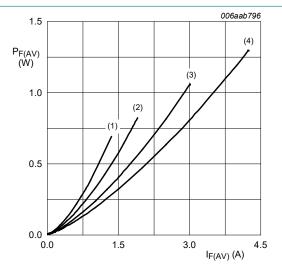
(1)  $T_i = 125 \,^{\circ}C$ 

 $(2) T_i = 85 ^{\circ}C$ 

 $(3) T_i = 25 ^{\circ}C$ 

(4)  $T_j = -40 \, ^{\circ}C$ 

Fig. 5. Reverse current as a function of reverse voltage; typical values



T<sub>i</sub> = 150 °C

 $(1) \delta = 0.1$ 

 $(2) \delta = 0.2$ 

 $(3) \delta = 0.5$ 

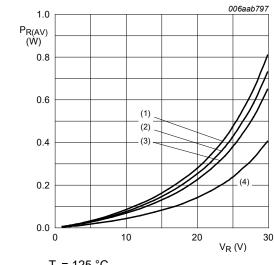
 $(4) \delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

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V<sub>R</sub> (V)



T<sub>j</sub> = 125 °C

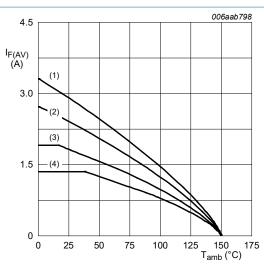
 $(1) \delta = 1$ 

 $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$ 

 $(4) \delta = 0.5$ 

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T<sub>i</sub> = 150 °C

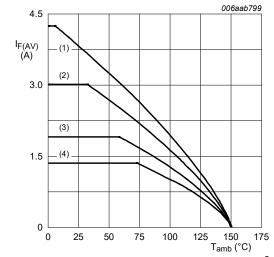
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 150 °C

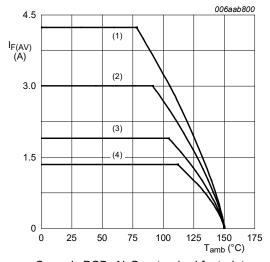
 $(1) \delta = 1$ ; DC

 $(2) \delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

 $T_i = 150 \,{}^{\circ}\text{C}$ 

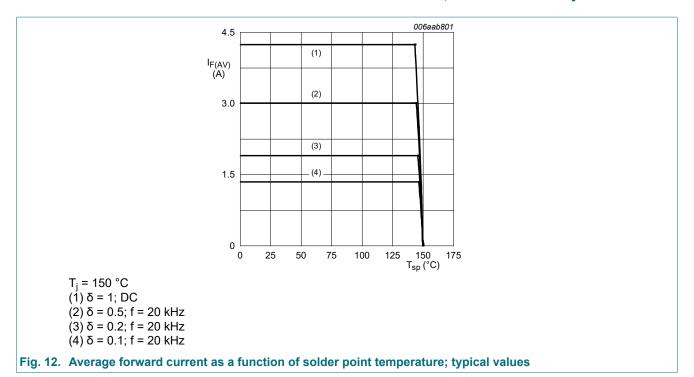
 $(1) \delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

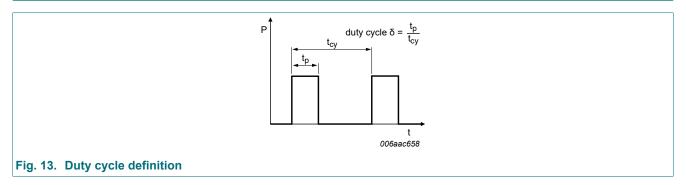
(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



# 11. Test information



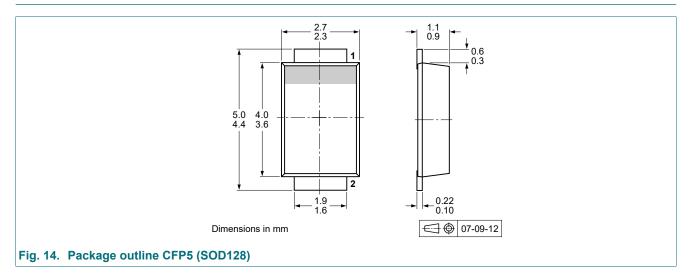
The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

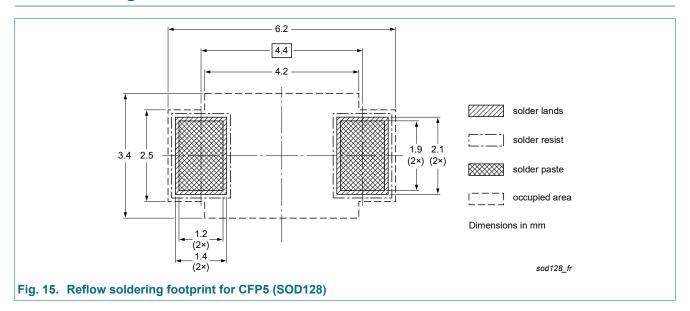
 $I_{RMS} = I_{F(AV)}$  at DC

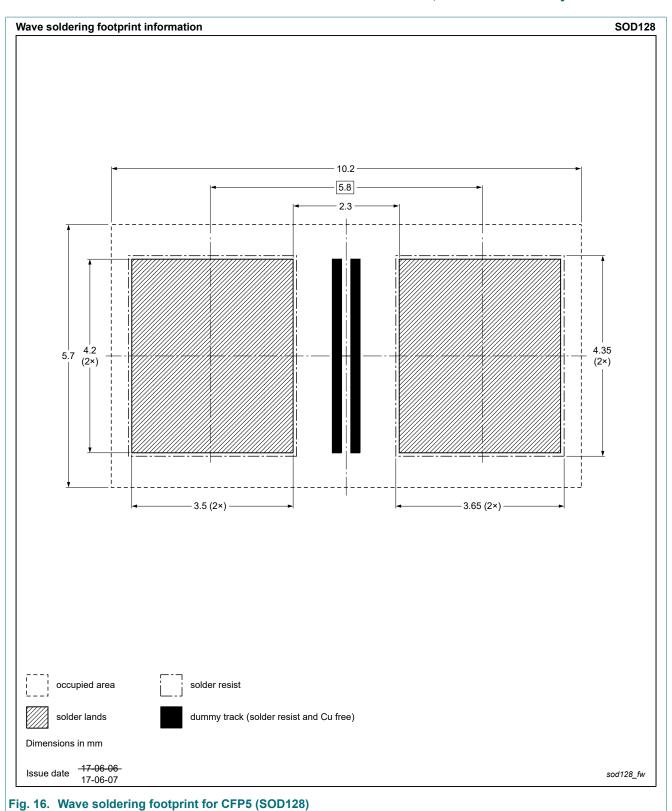
 $I_{RMS} = I_{M} \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current

# 12. Package outline



# 13. Soldering





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# 14. Revision history

### Table 8. Revision history

Table 6. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG3030BEP v.4	20230220	Product data sheet	-	PMEG3030BEP v.3			
Modifications:	Limiting values: Meawave.	asurement conditions for l	<sub>FSM</sub> changed from square	e wave to half-sine			
PMEG3030BEP v.3	20230101	Product data sheet	-	PMEG3030BEP v.2			
PMEG3030BEP v.2	20180326	Product data sheet	-	PMEG3030BEP v.1			
PMEG3030BEP v.1	20091027	Product data sheet	-	-			

# 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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